

Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	400	V
DC Blocking Voltage	V_{RM}		
Average Rectified Output Current (See Figure 1)	Io	6	Α
Non-Repetitive Peak Forward Surge Current 8.3ms	Isou	220	Δ
Single Half Sine-Wave Superimposed on Rated Load	IFSM	220	Α

Thermal Characteristics

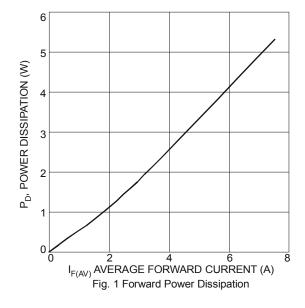
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Junction to Ambient (Note 3)	$R_{\Theta JA}$	30	°C/W
Maximum Thermal Resistance Junction to Case (Note 4)	R _{eJC}	2.5	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175	°C

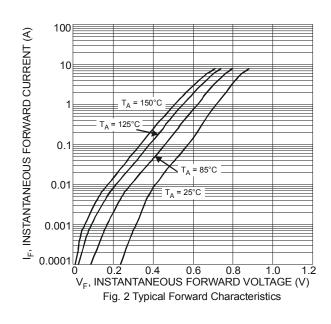
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
		_	0.83	-		I _F = 5A, T _J = 25°C
Forward Voltage Drop	V_{F}	-	0.85	0.91	V	I _F = 6A, T _J = 25°C
		-	0.72	0.77	V	I _F = 6A, T _J = 125°C
Leakage Current (Note 5)		-	0.8	50	μA	V _R = 400V, T _J = 25 °C
Leakage Current (Note 5)	I _R	-	-	5	mA	V _R = 400V, T _J = 125 °C
	trr		120		nS	$I_F = 0.5A$, $I_R = 1.0A$,
Reverse Recovery Time	un	_	120	_	113	$I_{RR} = 0.25A$
Junction Capacitance	CJ	-	100	-	pF	V _R = 4.0V, f = 1MHz

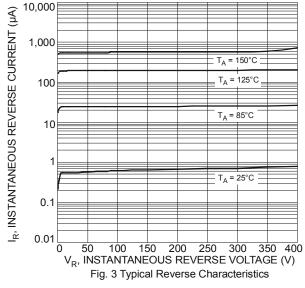
Notes:

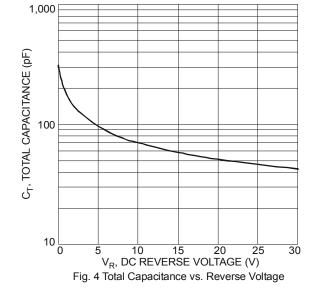
- 3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 4. Device mounted on Polymide substrate PC board, 16*MRP layout http://www.diodes.com.
- 5. Short duration pulse test used to minimize self-heating effect.

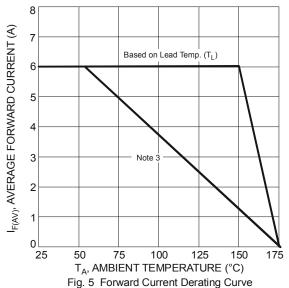




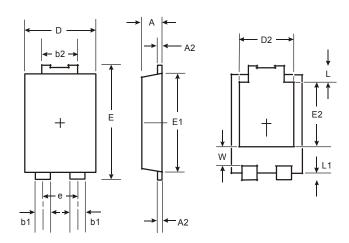








Package Outline Dimensions



POWERDI [®] 5			
Dim	Min	Max	
Α	1.05	1.15	
A2	0.33	0.43	
b1	0.80	0.99	
b2	1.70	1.88	
D	3.90	4.05	
D2	3.054 Typ		
Е	6.40	6.60	
е	1.84 Typ		
E1	5.30	5.45	
E2	3.549 Typ		
L	0.75	0.95	
L1	0.50	0.65	
W	1.10	1.41	
All Dimensions in mm			

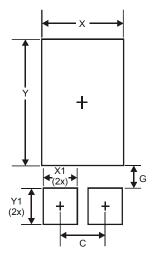
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SBR6U400P5

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Suggested Pad Layout



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400

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